# Homework 11: Reliability and Safety Analysis Due: Friday, April14, at NOON

#### Team Code Name: <u>Digital Real Time Intelligent Networked Kegerator</u> Group No. <u>4</u>

# Team Member Completing This Homework: <a href="mailto:Dustin Poe">Dustin Poe</a>E-mail Address of Report Author: <a href="mailto:depoe@purdue.edu">depoe@purdue.edu</a>

NOTE: This is the third in a series of four "professional component" homework assignments, each of which is to be completed by one team member. The completed homework will count for 10% of the team member's individual grade. It should be a minimum of five printed pages.

#### **Evaluation:**

<b>Component/Criterion</b>	Score	Multiplier	Points
Introduction and Summary	0 1 2 3 4 5 6 7 8 9 10	X 1	
Reliability Analysis	0 1 2 3 4 5 6 7 8 9 10	X 2	
Failure Mode, Effects, and Criticality Analysis	0 1 2 3 4 5 6 7 8 9 10	X 3	
Appendix A	0 1 2 3 4 5 6 7 8 9 10	X 1	
Appendix B	0 1 2 3 4 5 6 7 8 9 10	X 1	
List of References	0 1 2 3 4 5 6 7 8 9 10	X 1	
Technical Writing Style	0 1 2 3 4 5 6 7 8 9 10	X 1	
		TOTAL	

#### **Comments:**

#### **1.0 Introduction**

This document provides the Reliability and Safety information for the Digital Real Time Intelligent Network Kegerator. The Digital Real-Time Intelligent Networked Kegerator is a modular addition to an existing beverage dispensing device. The DRINK system provides the owner with complete beverage control, allowing owners to monitor user's consumption, set consumption limits, or completely restrict access. In this reliability analysis, components with a high likelihood of failure were identified. For these components, the number of failures per hour and the mean time to failure (MTTF) were determined. Also provided in this document is the Failure Mode, Effects, and Criticality Analysis (FMECA) for each modular block of the DRINK system. This Analysis gives insight into the failure modes of the system. The majority of the failure modes will result in a loss of functionality which is a major inconvenience to the user, but would not result in injury. However, there are a few failure modes identified as being potentially hazardous to the user and the entire system. These failures and potential solutions will be discussed in detail.

#### 2.0 Reliability Analysis

#### 2.1 Component Selection

Several components were identified in this system that could contribute to increased failure rates of the system. These components were chosen because of their elevated temperatures and/or frequency of use. The components are the compressor contactor (MGM Power Relay), power MOSFETS (TIP122), switching regulators (LTC1265-3.3, -5), and the flow solenoids. For each component, the numbers of failures per hour was calculated using MIL-HDBK-217F. <sup>1</sup> For all components  $\lambda_b$  represents the base failure rate. The base failure rate was then adjusted using environmental and manufacturing parameters to get  $\lambda_p$  the number of failures per hour. The mean time to failure (MTTF) was then calculated using the inverse of the number of failures per hour. <sup>2</sup>

#### 2.1.1 Compressor Contactor

The failure rate for the contactor can be determined using the following formula from MIL-HDBK-217F Section 13.1.

$$\lambda_p = \lambda_b \pi_L \pi_C \pi_{CYC} \pi_F \pi_Q \pi_E$$
 Failures/10<sup>6</sup> Hours

Factor	Description	Value	Explanation	
			Based on Internal worst case temperature in	
			Compressor Compartment, 50 degrees C, and	
			assuming rated temperature of contactor is 125	
			degrees C. However, contactor is rated for 155	
$\lambda_{\mathbf{b}}$	Base Failure Rate	0.0066	degrees C. <sup>31</sup>	
	Load Stress		Ratio of Load Current to Rated Current is	
$\pi_{ m L}$	Factor	1.04	.16666 and load is an inductive motor. <sup>31</sup>	
	Contactor Form			
$\pi_{\mathrm{C}}$	factor	1	Value for Single Throw Single Pole Relay <sup>31</sup>	
$\pi_{CYC}$	Cycling Factor	1	10 cycles per hour and lower quality <sup>1</sup>	
	Application and		The signal current was assumed to be 5Amps,	
	Construction		with medium power rating, and it is	
$\pi_{ m F}$	Factor	6	magnetically latching <sup>31</sup>	
			The quality factor is not established. Assuming	
$\pi_{ m Q}$	Quality Factor	3	worst case <sup>1</sup>	
	Environmental		Assuming Moderately controlled environment	
$\pi_{ m E}$	Factor	5	and non mil grade part <sup>1</sup>	
$\lambda_{\mathbf{p}}$	Failure Rate	0.618 Failures in 10 <sup>6</sup> Hours		
	Mean time to		<b>1.62 x 10<sup>6</sup> Hours or</b>	
MTTF	Failure		185 years	

 Table 2.1.1 Reliability Parameters for the Compressor Contactor

The compressor contactor was chosen to have a high likelihood of failure for several reasons. First, because the contactor is located in the compressor compartment it will have higher ambient temperatures than any other component in the design. Second, due to temperature regulation it is estimated that the contactor will switch frequently, an estimated 10 times an hour. In addition if this contactor fails closed there could be potential harm to the system and user. In this failure mode the compressor would be continuously driven. The MTTF rate for this device needs to be  $1 \times 10^9$  to have complete control over the compressor. It is highly recommended that owners keep the original temperature circuit in series with this device but set at a much higher temperature level. Finally in future models, an inclusion of an auxiliary contact for feedback purposes would greatly increase detecting of failure. This would allow for a software comparison of the drive signal with the feedback signal.

#### 2.1.2 **Power MOSFETS**

The failure rate for the contactor can be determined using the following formula from MIL-HDBK-217F Section 6.4.<sup>1</sup>

$$\lambda_p = \lambda_b \pi_T \pi_A \pi_Q \pi_E$$
 Failures/10<sup>6</sup> Hours MIL Section 6.4

Factor	Description	Value	Explanation		
$\lambda_{b}$	Base Failure Rate	0.012	Value for MOSFET <sup>1</sup>		
π	Temperature Factor	6.7	Based on Absolute max ratings from data sheet.150 degrees C <sup>41</sup>		
$\pi_{\mathrm{A}}$	Application Factor	4	$5W \le 12W < 50W^{-1}$ Power MOSFET $12V*1A=12W^{-41}$		
$\pi_{\rm Q}$	Quality Factor	8	Assuming worst quality Factor Plastic <sup>1</sup>		
$\pi_{\rm E}$	Environmental Factor	6	Assume GF since located in moderately controlled. Potential for excess heating, or humidity <sup>1</sup>		
$\lambda_{\mathbf{p}}$	Failure Rate	$15.44 = Failures in 10^6 Hours$			
MTTF	Mean time to Failure	648 x 10 <sup>6</sup> Hours or 7.39 years			

 Table 2.1.2 Reliability Parameters for the Power MOSFETS

The power MOSFETS in this design were chosen because they are operating above room temperature. In this analysis, a worst case junction temperature of 150 degrees C was used.<sup>3</sup> In reality, the junction temperatures will probably never approach 100 degrees C. The MTTF for this part is unacceptable. Since this device won't function without this component, the failure rate should be at least  $1 \times 10^6$  Hours until failure. It is recommended that higher quality parts be used in commercial use. Failure of this component will result in the solenoids remaining open or closed. If this part fails on the contactor, the compressor will be continually forced on or off. It is also recommended that two of these MOSFETS be used in series. This provides the ability to still shutoff the compressor if one fails closed.

## 2.1.3 Switching Regulator 3.3V and 5V

The failure rate for the regulars can be determined using the following formula in MIL-HDBK-217F Section 5.1.<sup>1</sup>

Factor	Description	Value	Explanation		
	Die Complexity		Assuming worst case there no more than 300		
C <sub>1</sub>	Failure Rate	0.02	transistors in device.		
			Absolute worst Junction Temperature is 125		
			Degrees C <sup>5</sup>		
$\pi_{\mathrm{T}}$	Temperature	58	For a Linear Device <sup>1</sup>		
			14 Pin Surface Mount Plastic Package <sup>51</sup>		
<b>C</b> <sub>2</sub>	Package Failure Rate	.0048			
	Environmental		Assuming moderately controlled environment		
$\pi_{ m E}$	Factor	2	and non mil grade part <sup>1</sup>		
$\pi_{ m Q}$	Quality Factor	10	Assuming unknown quality level <sup>1</sup>		
$\pi_{ m L}$	Learning Factor	1	Product has been in Market since 1995 <sup>5</sup>		
λ <sub>p</sub>	Failure Rate	0.111 Failures in 10 <sup>6</sup> Hours			
	Mean time to	8.96 x 10 <sup>6</sup> Hours or			
MTTF	Failure	102 year	rs		

$\lambda_p = (C_1 \pi_T + C_2 \pi_I)$	$\pi_Q \pi_L$ Failures/10 <sup>6</sup> Hours
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Table 2.1.3 Reliability Parameters for the Switching Regulators

This component was chosen because it's high junction temperature. In this design there are two switching regulators each powering different sources in the system. In either case of failure, the system will be virtually useless. Most failure modes of this device will not cause harm to the user or system. However, if this device has a short to ground it could cause a potential fire. The MTTF for this part is somewhat high for being a critical part in this design. It should be noted that the junction temperature will probably never exceed 100 degrees C in this design. To increase reliability /it is recommended that an external fuse be placed inline with each power supply to prevent a fire from occurring.

## 2.1.4 Solenoid Valve

The failure rate for solenoids can be modeled from the relay section 13.1 of the MIL-HDBK-217F.<sup>1</sup>

$$\lambda_p = \lambda_b \pi_L \pi_C \pi_{CYC} \pi_F \pi_Q \pi_E$$
 Failures/10<sup>6</sup> Hours

Factor	Description	Value	Explanation
$\lambda_{b}$	Base Failure Rate	0.0066	Based on Operating Temperature, 49 degrees C <sup>61</sup>
$\pi_{ m L}$	Load Stress Factor	1	Virtually No Load only actuating contactor <sup>61</sup>
	Contactor Form		
$\pi_{\mathrm{C}}$	factor	3	Value for Double Throw Double Pole Relay <sup>61</sup>
			Worst Case Scenario 60 cycles per hour and lower
$\pi_{CYC}$	Cycling Factor	6	quality <sup>1</sup>
	Application and		
	Construction		
$\pi_{ m F}$	Factor	12	General Purpose Solenoid with 1.2A Signal <sup>61</sup>
			The quality factor is not established. Assuming
$\pi_{\mathrm{Q}}$	Quality Factor	3	worst case <sup>1</sup>
	Environmental		Assuming Moderately controlled environment and
$\pi_{ m E}$	Factor	5	non mil grade part <sup>1</sup>
λ <sub>p</sub>	Failure Rate	21.4 Failure	s in 10 <sup>6</sup> Hours
	Mean time to	468 x 10 <sup>6</sup> He	ours or
MTTF	Failure	5.33 years	

 Table 2.1.4 Reliability Parameters for the Solenoid Valve

This component was chosen because of its frequency of use, up to 60 cycles an hour. In addition, the solenoids require 1.2 Amps at 12V to power the actuation. This will cause heating in the component that may lead to more failures. The MTTF failure for this part is unacceptable because without fundamental operation cannot occur. A failure rate of  $1 \times 10^6$  is necessary for component in commercial operation. To increase the reliability for this component the number of cycles an hour should be reduced.

# 3.0 Failure Mode, Effects, and Criticality Analysis (FMECA)

# 3.1 Division of Functionality

A Failure Mode Effects and Criticality Analysis was performed on the entire DRINK system. To simply this analysis the system was broken into functional blocks. This division can be seen in <u>Appendix A</u>. In the blocks shown below each border color and letter correspond to a section in <u>Appendix A</u>.

## 3.1.1 Common Beverage Interface

A picture of the common beverage interface is shown below. Due to the symmetry of this interface, only one beverage line is shown. This interface provides all the necessary signals for each beverage. Each interface has six signals: three for the flow meter, two for the solenoid valve, and one to indicate a beverage is connected. The failure mode\ analysis for this block can be found in <u>Appendix B</u>.

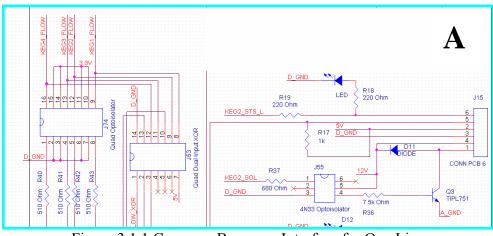
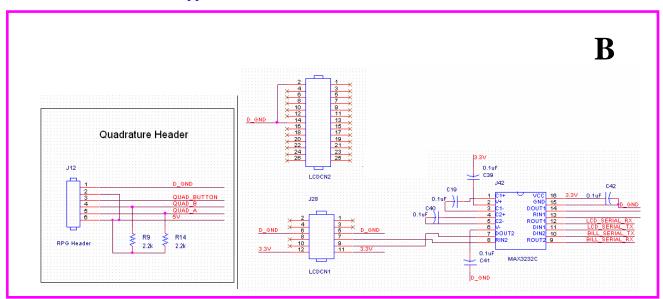


Figure 3.1.1 Common Beverage Interface for One Line

# 3.1.2 3.3V LCD and RPG Interface

Figure 3.1.2 shows a picture of the functional block for the LCD. This block contains the RS-232 chip which converts a 3.3V Signal into  $\pm$  15V. In addition, this interface contains all the necessary headers for the LCD and Rotary Pulse Generator. The failure mode analysis for this block can be found in <u>Appendix B</u>.



#### Figure 3.1.2 LCD and RPG Interface

#### **3.1.3** Temperature Control Interface

A picture of the temperature control interface is shown below in Figure 3.1.3. This interface contains the headers to two temperature probes, and the driver for the compressor contactor. One probe is located inside the refrigerator, while the other is ambient temperature. The compressor contactor interrupts the AC power to the refrigerator compressor. The failure mode analysis for this block can be found in <u>Appendix B</u>.

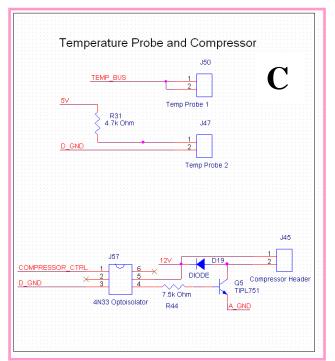


Figure 3.1.3 Temperature Control Interface

#### 3.1.4 5V Power Circuit

Figure 3.1.4 shows the 5V Power Circuit. This circuit is responsible for powering the RFID module, the flow meters, biometric sensor, and the temperature probes. The failure modes for this block can be found in <u>Appendix B</u>.

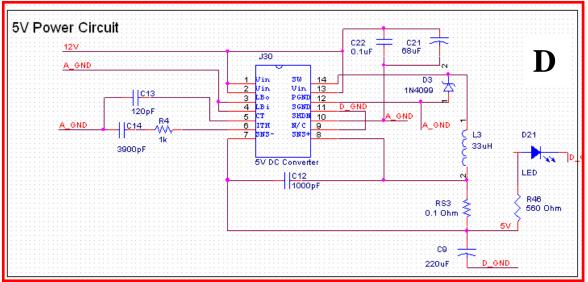


Figure 3.1.4 - 5V Power Circuit

# 3.1.5 3.3V Power Circuit

Shown below in Figure 3.1.5 is the 3.3V power supply and circuit. This circuit is responsible for powering the Rabbit microprocessor, and the RS-232 translator chips. The failure mode analysis for this block can be found in <u>Appendix B</u>.

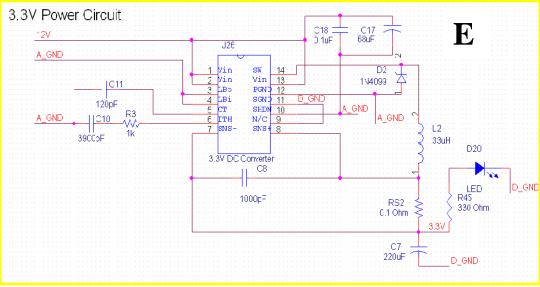


Figure 3.1.5 - 3.3V Power Circuit

# 3.1.6 User Identification Interface

The User Identification Interface is shown in Figure 3.1.6. Within this interface is the RFID reader which will be used to determine cup size, and the header to the Biometric Thumb print

reader which will be used to recognize users in the system. The failure mode analysis for this block can be found in <u>Appendix B</u>.

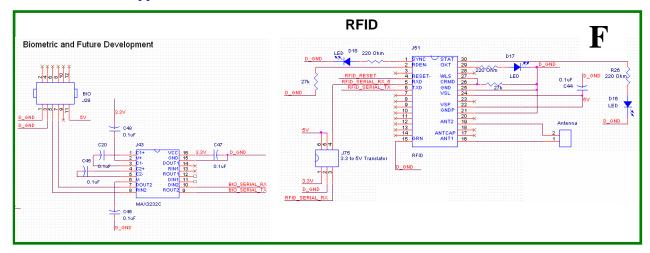


Figure 3.1.6 User Identification Interface

# 3.1.7 Currency Acceptor Interface

Figure 3.1.7 shows the Currency Acceptor Interface. This section features an RS-232 level translator along with signal and power headers to the Currency Acceptor. The failure mode analysis for this block can be found in <u>Appendix B</u>.

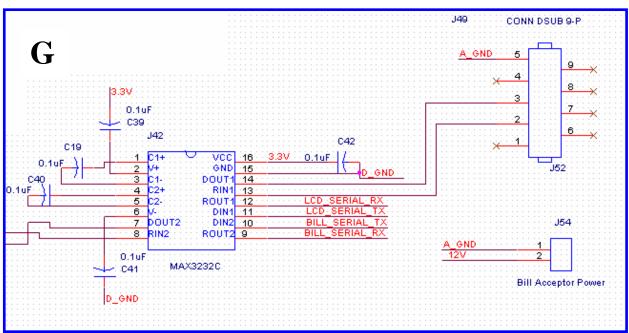


Figure 3.1.7 Currency Acceptor Interface

# 3.1.8 Rabbit Module Circuit

Figure 3.1.8 shows the Rabbit Module Circuit. Within this circuit are the headers to the Rabbit Microprocessor, and audio transducer, reset switch, and backup battery for memory. . The failure mode analysis for this block can be found in <u>Appendix B</u>.

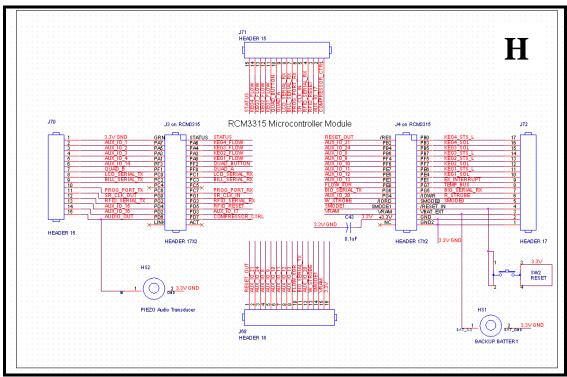


Figure 3.1.8 Rabbit Module Circuit

# **3.2 Definitions of Criticality Levels**

The criticality levels, their definition and the acceptable failure rates are shown in Table 3.2.

Level	Description of Failure	Acceptable Reliability Rates (Hours until Failure)
	Minor inconvenience, little or not affect on	
Low	system performance	$1 \ge 10^5$
	Harmless to User but results in Major Loss	
Med	of Functionality	$1 \ge 10^{6}$
	This failure can potentially cause heavy	
High	damage to the system and the user	$1 \ge 10^9$

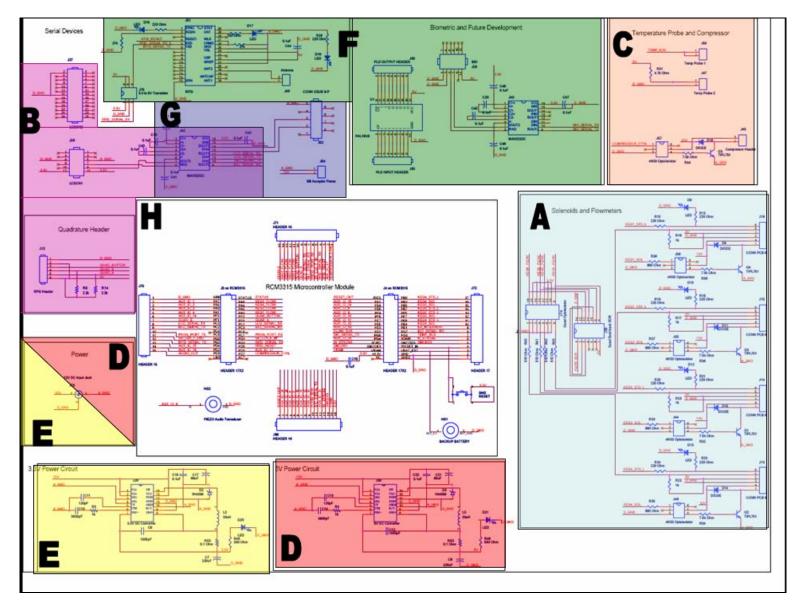
 Table 3.2 Definition of Criticality Levels.

#### 4.0 Summary

In this document, the reliability of the Digital Real-Time Intelligent Networked Kegerator was analyzed. For components identified as higher likelihood of failure the number of failures in an hour, and mean time to failure was also calculated. It was found the reliability of any of the parts was not acceptable. Further design or inclusion of a backup system will be necessary to meet the required reliability rates. In the second part of this analysis the schematic was divided up into functional sections. In each section every failure mode was identified along with its criticality on the overall system. The criticality was split into three levels. Low levels criticality failures were associated with errors that have little or not effect on performance. Medium criticality failures were associated with a major loss of functionality, but would result in no harm to user. Finally, high criticality failures were associated with failures that would result in potential harm to the user, and the entire system. List of References

- [1] MIL-HDBK-217F Military Handbook of Reliability Prediction of Electronic Equipment http://shay.ecn.purdue.edu/~dsml/ece477/Homework/Spr2006/Mil-Hdbk-217F.pdf
- [2] Novak, George. Designing for Reliability, Maintainability, and Safety Circuit Cellar. Dec 2000 http://shay.ecn.purdue.edu/~dsml/ece477/Notes/PDF/4-Mod13\_ref.pdf
- [3] Omron Heavy Duty Power Relay Datasheet http://shay.ecn.purdue.edu/~477grp4/documents/specs/MGN0305PowerRelay.pdf
- [4] Fairchild NPN Epitaxial Darlington Transistor Datasheet http://shay.ecn.purdue.edu/~477grp4/documents/specs/TI-TIP122-1.pdf
- [5] Linear Technologies Step Down DC/DC Converter Datasheet http://shay.ecn.purdue.edu/~477grp4/documents/specs/LTC1265.pdf
- [6] Evolutionary Concepts Inc Series 2200 Specifications http://www.ecivalves.com/specs/SpecsS2200.htm

**IMPORTANT:** One of these should be *MIL-HDBK-217F*. Use standard IEEE format for references, and CITE ALL REFERENCES listed in the body of your report. <u>Any URLs</u> <u>cited should be "hot" links.</u>



**Appendix A: Schematic Functional Blocks** 

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# Appendix B: FEMCA Worksheet

Failure No.	Failure Mode	Possible Causes	Failure Effects	Method of Detection	Criticality	Remarks
		Flow meters,				
		Optocouplers				
		(J74) XOR (J53)				
		R40-R43,		Software		Could result in harm to
	No Dovoraço	connector, wire,	Inaccurate or Failure	Software, Observation on		
A1	No Beverage	microprocessor, software	to Monitor BAC	LCD	High	user if consumption no
AI	Monitoring		to Monitor BAC	LCD	High	properly monitored
		Solenoids, MOSFETS (Q1,				
		$Q_{2}, Q_{3}, Q_{4}$				
		(22, 03, 04) diodes (D14,				
		D15, D11, D9),				
		wire J56, J55, J44				
		J46, connectors,				
		wire,				
	Solenoids won't	microprocessor,	Inability to			
A2	open	software	dispense beverage	Observation,	Med	
	•	Solenoids,		, , , , , , , , , , , , , , , , , , ,		
		MOSFETS (Q1,				
		Q2, Q3, Q4)				
		diodes (D14,				
		D15, D11, D9),				
		optocouplers,	Inability to control			
		connectors, wire,	beverage flow.			Could result in harm to
	Solenoids won't	microprocessor,	Unrestricted access to			user if consumption no
A3	close	software	beer	Observation,	High	properly monitored

		connector, wire,				
		R15,	T 1. :1:4 4			
	KEG Showing	microprocessor,	Inability to serve		т	
A4	Not connected	software	all beverages	Observation,	Low	
		RPG, wire,				
		header, R9, R14,	T 1'1'' / NT ' /			
<b>D1</b>	Rotary Pulse	microprocessor,	Inability to Navigate	Observation on	T	
B1	Generator failure	software	through menu	LCD	Low	
		Wire, connector,				
		Noise,				
Da	LCD Improper	microprocessor,		Observation on		
B2	Display	software	Inability to see Menu	LCD	Med	
		J42, connector,				
		wire,				
<b>D</b> 2		microprocessor,		Observation on		
<b>B3</b>	LCD Failure	software	Inability to See Menu	LCD	Med	
		<b>T</b> (	T (			
		Temperature	Inaccurate			Could result in damage
	T	Probes, R31,	Temperature	C - C		or fire to refrigerator. Recommended to use
	Improper or	Connector, Wire,	Regulation,	Software, Observation on		
C1	No Temperature	microprocessor, software	Compressor Failure,	LCD	Iliah	backup emergency
C1	Monitoring		Overheating	LCD	High	temperature controller
		Contacts on relay melded ,shut,				Cauld manult in damage
		MOSFET Failure				Could result in damage or fire to refrigerator.
		Q5, J57,				Recommended to use
	Contactor Driven		Compressor Failure,			
C2	Constant High	microprocessor, software	Overheating	Observation,	High	backup emergency temperature controller
C2		Relay Failure,	Overneating		Tingii	
		MOSFET, Q5,				
		J57,				Non Regulation of
	Contactor Driven	microprocessor,	Inability to Cool			Temperature would
C3	Constant Low	software	Beverage,	Observation,	Med	result in warm beverage
C.J	Constant Low	SUILWAIC	Develage,	Observation,	IVICU	result in warm bevelage

			Unpredicted	Observation,		
			Behavior and			
			potential damage to			
			Serial			
			Communications,			Unpredictable may
			RFID, flow meters			result in excess current/
			temperature probes,			Damage to micro is due
	Voltage Output	External PS,	also potential to			to fact that some pins
D1	>5V	J30,D3	damage Micro.		High	have 5V Input
			Loss of RFID, and	Observation,		
			Biometric, ability to			
			monitor temp and			
			flow. Could result in			
		Any component	fire due to short to			
D2	Voltage Output=0	in Block D	ground		High	TBD
		Any component is	Out of Spec	Observation,		
D3	Out of Tolerance	Block D	Operating Voltage		Med	TBD
			Unpredicted			
			Behavior and			
			potential damage to			
	Voltage Output	External PS,	RFID and			
<b>E1</b>	>3.3	J26,D2	Microprocessor	Observation,	High	
			Complete Loss of			
			Functionality since			
		Any component	Microprocessor is not			
		in Block D,	powered. A short to			
		Power and	ground could cause			
E2	Voltage Output=0	Ground Short	potential fire	Observation,	High	
		Any component is	Out of Spec			
E3	Out of Tolerance	Block D	Operating Voltage	Observation,	Med	

		Antenna, RFID				
		chip(J51), Level				
		Translator, J75,	Unable to Identify			
		microprocessor,	cup size	Observation,		
F1	Failure of RFID	software	cannot limit flow	Software	Low	
		Thumb Print				
		Reader, RS232				
		level translator				
		(J43),	Inability to Identify			
	Failure of	microprocessor,	Users, therefore to			
F2	Biometric	software	serve beverage	Observation,	Med	
		Antenna, RFID				
		chip(J51), Level	Incorrect			
		Translator J75,	identification of cup			
	Invalid RFID	RFID	size and incorrect	Observation,		
<b>F3</b>	Match	Transponder	flow limit	Software	Low	
		Thumb Print	Incorrect			Could result in harm to
		Reader, RS232	identification of			user if consumption is
	Invalid Finger	level translator	users, unauthorized	Observation,		recorded for wrong
F4	Match	(J43)	pours	Software	High	user.
		RS-232 Cable,				
		J42, Dollar Bill				
	Dollar Bill	Acceptor,	L 1'1' ( D			
C1	Acceptor Fails	microprocessor,	Inability to Buy Credits for Drinks	Observation	Mad	
G1	Off	software RS-232 Cable,	Credits for Drinks	Observation,	Med	TBD
		J42, Dollar Bill				
		Acceptor,				
	Dollar Bill	microprocessor,	Accepts Dollars/but			
G2	Acceptor Fails On	software	doesn't give credits	Observation,	Med	
	Audio Transducer	Microprocessor,	Speaker has		11104	
H1	Stuck High	software	continuous noise	Observation	Low	
111	Stuck Ingh	Soliware			LUW	

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			Inability to remotely			
			control Kegerator,			
	Web server	Microprocessor,	view users statistics,			
H2	crashes	software	add manage or users.	Observation	Med	

It is not necessary to calculate the probability of each failure mode. These numbers would usually be taken from the reliability analysis, but since you are not performing a complete analysis, they do not need to be included in your FMECA worksheet.